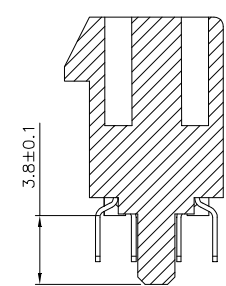
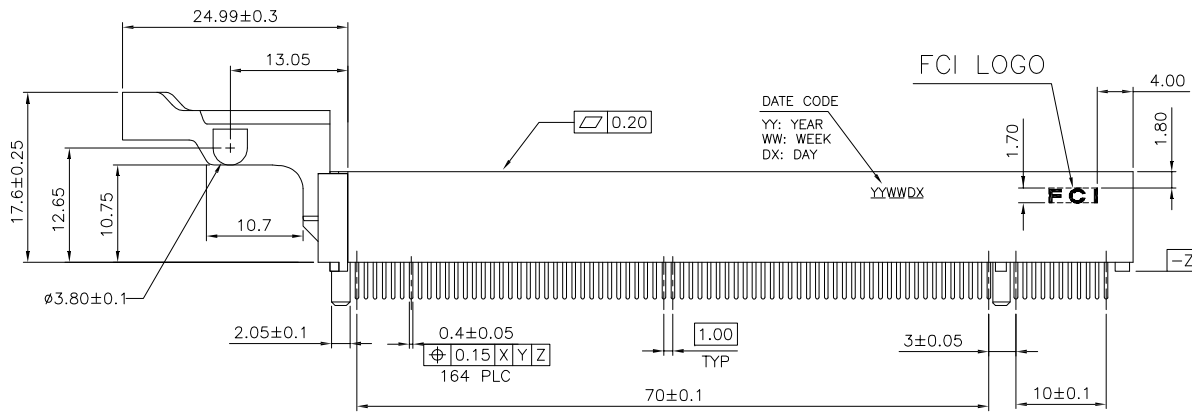
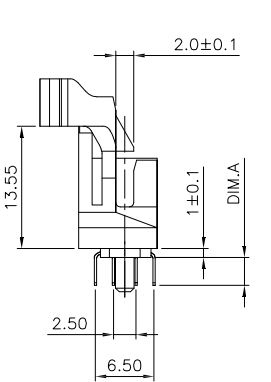
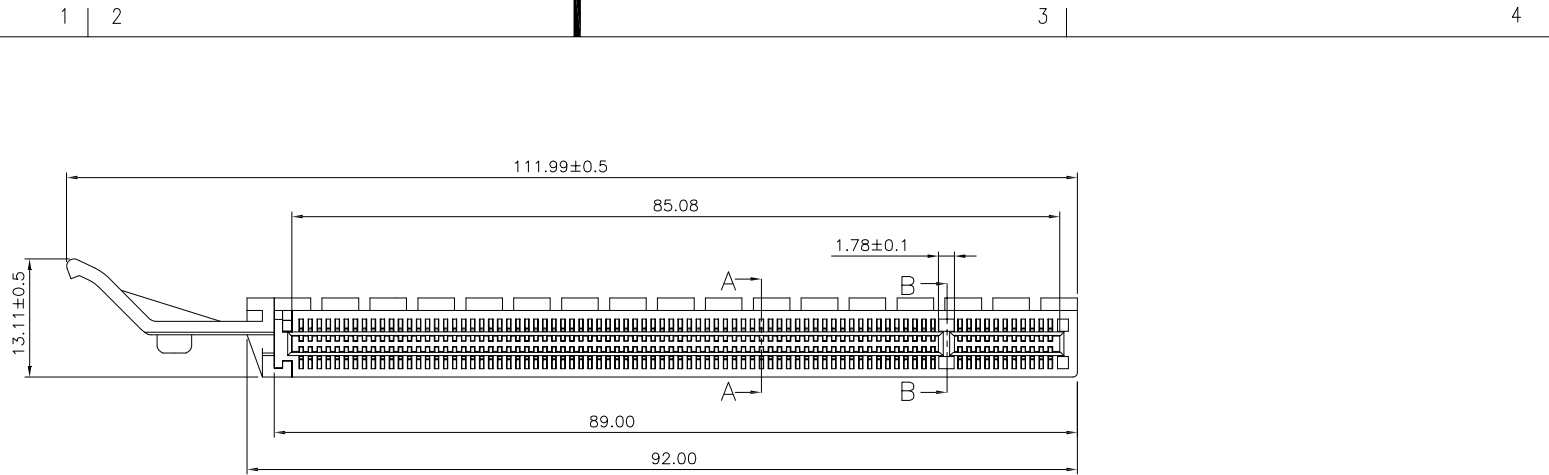
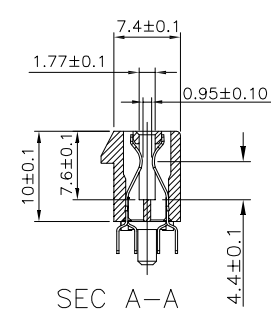




A



SEC B-B  
SECALE 2:1

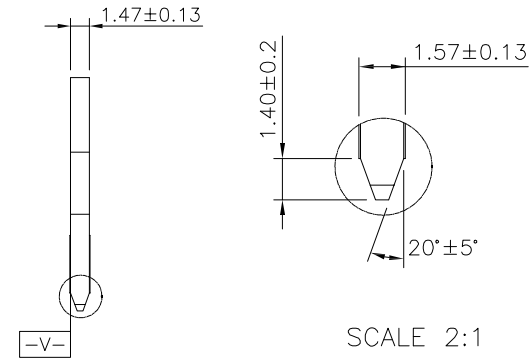
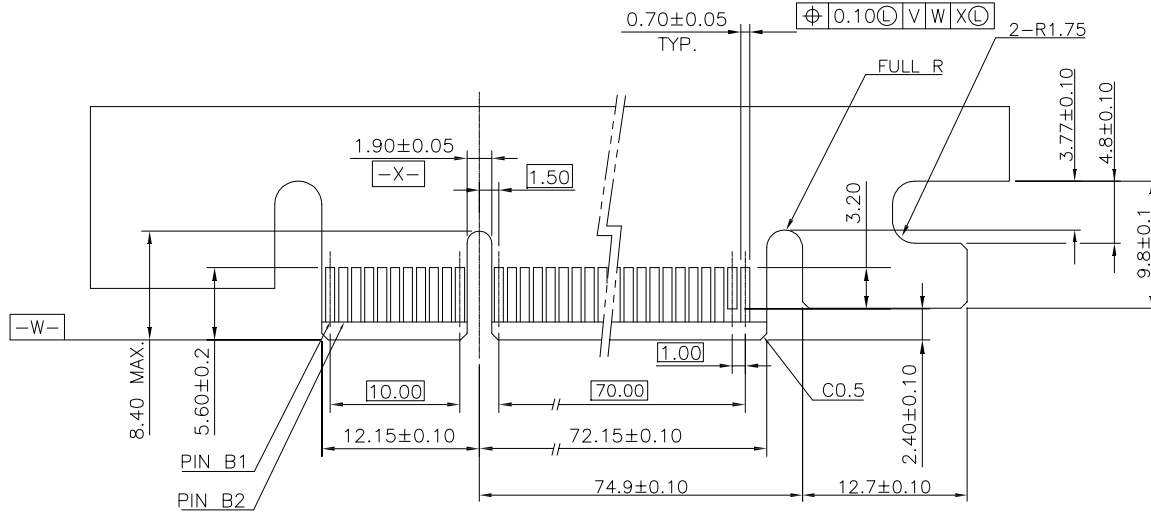


SEC A-A

PART NUMBER	DIM.A
10083987-XXX13TLF	3.10±0.15
10083987-XXX23TLF	2.30±0.15

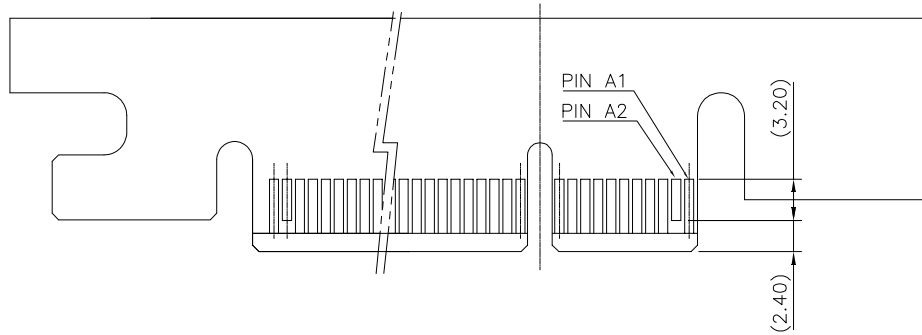
mat'l. code				tolerances unless otherwise specified			CUSTOMER COPY		FCI www.fciconnect.com	
ltr	ecn no	dr	date	linear	.X ± 0.38		projection		title PCI-E INTEGRATED TYPE GEN3 CARD EDGE ASS'Y	
A	T07-1180	J.H	12/27/07		.XX ± 0.25					
B	T10-0030	J.H	1/03/10	angles	.XXX ± 0.10		MM		product family EDGE CARD code TWN	
C	ELX-DG-2161-1	ST	05/27/16		0° ± 2°		scale 1:1		size dwg no 10083987 sheet 1 of	
sheet index	revision sheet	C 1	C 2	C 3	dr	STONE LI	05/27/15			
					enrg	STONE LI	05/27/15			
					chr	/	/			
					appd	PM ZHENG	05/27/15			

cage code 22526

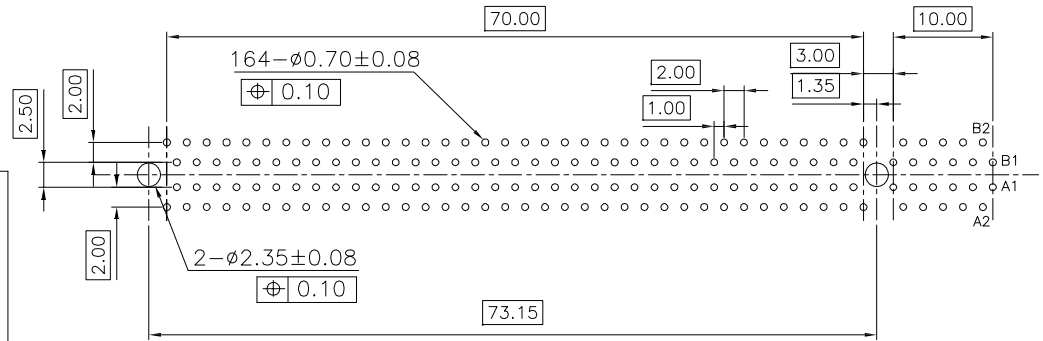


ADD-IN CARD EDGE-FINGER DIMENSIONS

I/O PANEL DIRECTION  
PRIMARY (COMPONENT) SIDE



I/O PANEL DIRECTION  
SECONDARY (SOLDER) SIDE



RECOMMENDED FOOTPRINT LAYOUT



mat'l. code				tolerances unless otherwise specified			CUSTOMER COPY		 www.fciconnect.com	
ltr	ecn no	dr	date	linear	.X ± 0.38		projection	title PCI-E INTEGRATED TYPE GEN3 CARD EDGE ASS'Y		
					.XX ± 0.25					
					.XXX ± 0.10					
				angles	0° ± 2°		 MM	product family		code
				dr	STONE LI	05/27/15		EDGE CARD	TWN	
				enr	STONF LI	05/27/15	scale	size dwg no		sheet
				chr	/	/	1:1	A4		2 of
				appd	PM ZHENG	05/27/15			cage code	
sheet index	revision sheet							22526		

NOTES:

1.MATERIAL:

HOUSING: THERMOPLASTIC WITH GLASS FIBER, UL94V-0,  
LATCHS: THERMOPLASTIC WITHOUT GLASS FIBER, UL94-HB (PA66).  
CONTACTS: COPPER ALLOY.

2.FINISH:

CONTACTS: GOLD PLATING ON CONTACT AREA,  
60u" MATTE TIN (LEAD FREE OPTION) PLATING ON SOLDER TAILS,  
50u" MIN. NICKEL UNDERPLATING OVER ALL.

3. WARNING: THE MAXIMUM ALLOWABLE ANGLE TO WITHDRAWAL THE DAUGHTER CARD FROM RETAINER  
BY 25 DEGREE.

4. DURABILITY: 50 CYCLES.

5. RoHS COMPATIBLE PRODUCT SPECIFICATIONS

- a. PLATING: "LF" MEANS THE PRODUCT IS LEAD FREE, 1.5um min. MATTE PURE TIN OVER 1.27um MIN. NICKEL UNDERPLATE.
- b. MANUFACTURING PROCESS COMPATIBILITY: THE HOUSING WILL WITHSTAND EXPOSURE TO 260C±5C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.57MM THICK CIRCUIT BOARD.

PRODUCT NUMBER CODE

10083987 -x x x x x x LF

HOUSING COLOR OPTIONS

- 1-BLACK FOR BASE & RM
- 4-BLUE (297C) FOR BASE & RM

PEGS OPTIONS

- 1-PLASTIC POST

TERMINAL PLATING OPTIONS

- 0-50u" Ni UNDERPLATE  
30u" Au CONTACT AREA  
100u" TIN TAIL AREA
- 1-50u" Ni UNDERPLATE  
15u" Au CONTACT AREA  
100u" TIN TAIL AREA
- 2-50u" Ni UNDERPLATE  
GOLD FLASH CONTACT AREA  
100u" TIN TAIL AREA

APPLICATIONS

LF- LEAD FREE FOR PLATING OPTIONS 0,1,2

PACKAGING OPTIONS

T-TRAY PACKAGING





POS OPTIONS

3-164

TAIL LENGTH OPTION (DIM.A)

- 1- 3.10MM
- 2- 2.30MM



mat'l. code				tolerances unless otherwise specified			CUSTOMER COPY		 www.fciconnect.com	
ltr	ecn no	dr	date	linear	.X ± 0.38	projection		title		
					.XX ± 0.25			PCI-E INTEGRATED TYPE GEN3 CARD EDGE ASS'Y 		
				angles	.XXX ± 0.10			product family		code
				dr	0° ± 2°	scale		EDGE CARD		TWN
				engr		1:1		size		sheet
				chr		A4		10083987		3 of
				appd						
sheet index	revision sheet									